



SBG1

ANION EXCHANGE RESIN
TYPE ONE GEL
Cl OR OH FORM

RESINTECH SBG1 is a high capacity, shock resistant, gelular, Type 1, strongly basic anion exchange resin supplied in the chloride or hydroxide form as moist, tough, uniform, spherical beads. *RESINTECH SBG1* is intended for use in all types of deionization systems and chemical processing applications. It is similar to *RESINTECH SBG1P* but has a higher volumetric capacity and exhibits lower TOC leach rates. This makes it the better performer in single use applications such as in cartridge deionization and when high levels of regeneration are used such as in polishing mixed beds. On the other hand, *RESINTECH SBG1P* is more resistant to organic fouling and gives higher operating capacities at low regeneration levels such as those used in make up demineralizers.

FEATURES & BENEFITS

- COMPLIES WITH FDA REGULATIONS FOR POTABLE WATER APPLICATIONS.**

Conforms to paragraph 21CFR173.25 of the Food Additives Regulations of the F.D.A.*

- HIGH TOTAL CAPACITY**

Provides longer run lengths in single use applications or where high levels of regeneration are used such as in mixed bed polishers, cartridge demineralizers.

- NSF/ANSI 61 CERTIFIED FOR MATERIAL SAFETY**

WQA Gold Seal Certified when ordered as SBG1-HP



- UNIFORM PARTICLE SIZE**

16 to plus 50 mesh range; gives a LOWER PRESSURE DROP while maintaining SUPERIOR KINETICS.

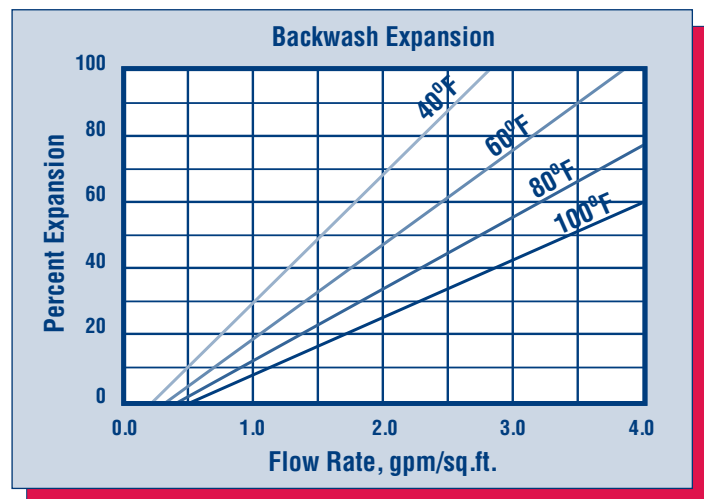
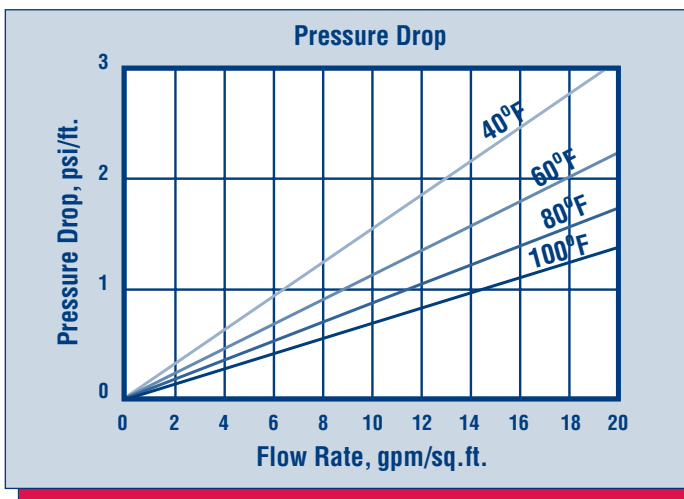
- SUPERIOR PHYSICAL STABILITY**

- LOWER TOC LEACH RATE**

Makes it ideal for polishing mixed beds in wafer washing and other high purity water polishing applications.

* For potable water applications, the resin must be properly pre-treated, usually by multiple exhaustion and regeneration cycles, to ensure compliance with extractable levels

HYDRAULIC PROPERTIES



PRESSURE DROP

The graph above shows the expected pressure loss per foot of bed depth as a function of flow rate, at various temperatures.

BACKWASH

After each cycle the resin bed should be backwashed at a rate that expands the bed 50 to 75 percent. This will remove any foreign matter and reclassify the bed. The graph above shows the expansion characteristics of *RESINTECH SBG1* in the sodium form.

RESINTECH® SBG1

PHYSICAL PROPERTIES

Polymer Structure	Styrene Crosslinked with DVB
Functional Group	R-N-(CH ₃) ₃ ⁺ Cl ⁻
Ionic Form, as shipped	Chloride or Hydroxide
Physical Form	Tough, Spherical Beads
Screen Size Distribution	16 to 50
+16 mesh (U.S. Std)	< 5 percent
-50 mesh (U.S. Std)	< 1 percent
pH Range	0 to 14
Sphericity	> 93 percent
Uniformity Coefficient	Approx. 1.6
Water Retention	
Chloride Form	43 to 50 percent
Hydroxide Form	Approx. 53 to 60 percent
Solubility	Insoluble
Approximate Shipping Weight	
Cl Form	44 lbs/cu.ft.
OH Form	41 lbs/cu.ft.
Swelling Cl- to OH-	18 to 25 percent
Total Capacity	
Cl Form	1.45 meq/ml min
OH Form	1.15 meq/ml min

SUGGESTED OPERATING CONDITIONS

Maximum Continuous Temperature	
Hydroxide Form	140° F
alt Form	170° F
Minimum Bed Depth	24 inches
Backwash Rate	50 to 75 percent Bed Expansion
Regenerant Concentration*	2 to 6 percent
Regenerant Flow Rate	0.25 to 1.0 gpm/cu.ft.
Regenerant Contact Time	At least 40 Minutes
Regenerant Level	4 to 10 pounds/cu.ft.
Displacement Rinse Rate	Same as Regenerant Flow Rate
Displacement Rinse Volume	10 to 15 gals/cu.ft.
Fast Rinse Rate	Same as Service Flow Rate
Fast Rinse Volume	35 to 60 gals/cu.ft.
Service Flow Rates	
Polishing Mixed Beds	3 to 15 gpm/cu.ft.
Non-Polishing Apps.	2 to 4 gpm/cu.ft.

OPERATING CAPACITY

The operating capacity of *RESINTECH SBG1* for a variety of acids at various regeneration levels when treating an influent with a concentration 500 ppm, expressed as CaCO₃ is shown in the following table:

Pounds NaOH/ft ³	Capacity Kilograms per cubic foot			
	HCl	H ₂ SO ₄	H ₂ SiO ₃	H ₂ CO ₃
4	11.3	14.0	14.7	18.6
6	12.8	16.3	17.3	19.8
8	14.3	13.3	19.5	21.6
10	15.5	20.0	22.2	22.2

APPLICATIONS

DEMINERALIZATION –

RESINTECH SBG1 is highly recommended for use in mixed bed demineralizers, wherever complete ion removal; superior physical and osmotic stability and low TOC leachables are required such as in wafer fabrication and other ultrapure applications.

RESINTECH SBG1 has high total capacity and low swelling on regeneration and provides maximum operating capacity in cartridge deionization applications. It is ideal for single use applications such as precious metal recovery, radwaste disposal and purification of toxic waste streams.

Highly crosslinked Type 1, styrenic anion exchangers have greater thermal and oxidation resistance than other types of strong base resins. They can be operated and regenerated at higher temperatures. The combination of lower porosity, high total capacity and Type 1 functionality make *RESINTECH SBG1* the resin of choice when water temperatures exceed 85°F and where the combination of carbon dioxide, borate and silica exceed 40% of the total anions.

RESINTECH SBG1P and *RESINTECH SBG1* are quite similar; the difference between them is the degree of porosity. *RESINTECH SBG1P* has greater porosity that gives it faster kinetics, and greater ability to reversibly sorb slow moving ions such as Naturally occurring Organic Matter (NOM). At lower regeneration levels and where chlorides make up a substantial portion of the anion load, or where the removal and elution of naturally occurring organics is of concern *RESINTECH SBG1P*, SBACR or SBG2 should be considered. At the higher regeneration levels used in mixed bed polishers *RESINTECH SBG1* provides higher capacity, and the lowest possible TOC leach rates.

***CAUTION:DO NOT MIX ION EXCHANGE RESIN WITH STRONG OXIDIZING AGENTS.** Nitric acid and other strong oxidizing agents can cause explosive reactions when mixed with organic materials, such as ion exchange resins.

Material Safety Data Sheets (MSDS) are available for all ResinTech Inc. products. To obtain a copy, contact your local ResinTech sales representative or our corporate headquarters.

They contain important health and safety information. That information may be needed to protect your employees and customers from any known health and safety hazards associated with our products. We recommend that you secure and study the pertinent MSDS for our products and any other products being used. These suggestions and data are based on information we believe to be reliable. They are offered in good faith. However we do not make any guarantee or warranty. We caution against using these products in an unsafe manner or in violation of any patents; further we assume no liability for the consequences of any such actions.

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